



# **Dual P-Channel 2.5-V (G-S) MOSFET**

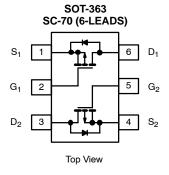
| PRODUCT SUMMARY     |                                  |        |  |  |  |
|---------------------|----------------------------------|--------|--|--|--|
| V <sub>DS</sub> (V) | $r_{DS(on)}(\Omega)$             |        |  |  |  |
| -20                 | 0.995 @ V <sub>GS</sub> = -4.5 V | ± 0.44 |  |  |  |
|                     | 1.190 @ V <sub>GS</sub> = -3.6 V | ±0.40  |  |  |  |
|                     | 1.80 @ V <sub>GS</sub> = −2.5 V  | ±0.32  |  |  |  |

#### **FEATURES**



- TrenchFET® Power MOSFET
- 2.5-V Rated
- Lead (Pb)-Free Version is RoHS Compliant

Available



Marking Code

QA XX 
Lot Traceability and Date Code

Part # Code

Ordering Information: Si1903DL-T1

Si1903DL-T1-E3 (Lead (Pb)-Free)

| ABSOLUTE MAXIMUM RATING                                  | S (T <sub>A</sub> = 25°C UN | ILESS OTHE                        | ERWISE NO  | TED)         |      |
|--|-----------------------------|-----------------------------------|------------|--------------|------|
| Parameter  |                             | Symbol                            | 5 secs     | Steady State | Unit |
| Drain-Source Voltage                                     |                             | V <sub>DS</sub>                   | -20        |              | .,   |
| Gate-Source Voltage                                      |                             | V <sub>GS</sub>                   | ±12        |              | V    |
| Continuous Drain Current (T,I = 150°C)a                  | T <sub>A</sub> = 25°C       | I <sub>D</sub>                    | ±0.44      | ±0.41        |      |
| Continuous Diam Current (1) = 130 O)                     | T <sub>A</sub> = 85°C       |                                   | ± 0.31     | ±0.30        | Α    |
| Pulsed Drain Current                                     |                             | I <sub>DM</sub>                   | ±1.0       |              | ^    |
| Continuous Diode Current (Diode Conduction) <sup>a</sup> |                             | I <sub>S</sub>                    | -0.25      | -0.23        |      |
| Maximum Power Dissipation <sup>a</sup>                   | T <sub>A</sub> = 25°C       | 5                                 | 0.30       | 0.27         | w    |
|  | T <sub>A</sub> = 85°C       | - P <sub>D</sub>                  | 0.16       | 0.14         | VV   |
| Operating Junction and Storage Temperature Range         |                             | T <sub>J</sub> , T <sub>stg</sub> | -55 to 150 |              | °C   |

| THERMAL RESISTANCE RATINGS               |              |                   |         |         |      |  |
|--|--------------|-------------------|---------|---------|------|--|
| Parameter                                |              | Symbol            | Typical | Maximum | Unit |  |
|  | t ≤ 5 sec    | R <sub>thJA</sub> | 360     | 415     |      |  |
| Maximum Junction-to-Ambient <sup>a</sup> | Steady State |                   | 400     | 460     | °C/W |  |
| Maximum Junction-to-Foot (Drain)         | Steady State | R <sub>thJF</sub> | 300     | 350     |      |  |

Notes

a. Surface Mounted on 1" x 1" FR4 Board.

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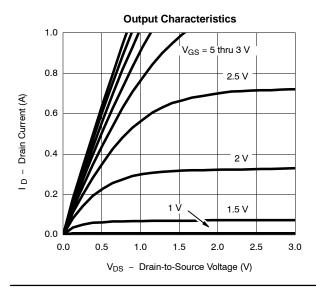
| SPECIFICATIONS (T <sub>J</sub> = 25°C UNLESS OTHERWISE NOTED) |   |   |      |       |       |      |  |  |  |
|---|---|---|------|-------|-------|------|--|--|--|
| Parameter   | Symbol  | Test Condition  | Min  | Тур   | Max   | Unit |  |  |  |
| Static  |   |   |      |       |       |      |  |  |  |
| Gate Threshold Voltage  | V <sub>GS(th)</sub>                             | $V_{DS} = V_{GS}, I_D = -250 \mu A$   | -0.6 |       | -1.5  | V    |  |  |  |
| Gate-Body Leakage   | I <sub>GSS</sub>                                | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$   |      |       | ± 100 | nA   |  |  |  |
| Zero Gate Voltage Drain Current                               | I <sub>DSS</sub>                                | V <sub>DS</sub> = -20 V, V <sub>GS</sub> = 0 V  |      |       | -1    |      |  |  |  |
|   |   | $V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 85^{\circ}\text{C}$                          |      |       | -5    | μΑ   |  |  |  |
| On-State Drain Current <sup>a</sup>                           | I <sub>D(on)</sub>                              | $V_{DS} = -5 \text{ V}, V_{GS} = -4.5 \text{ V}$  | -1.0 |       |       | Α    |  |  |  |
|   |   | $V_{GS} = -4.5 \text{ V}, \ I_D = -0.41 \text{ A}$  |      | 0.850 | 0.995 |      |  |  |  |
| Drain-Source On-State Resistance <sup>a</sup>                 | r <sub>DS(on)</sub>                             | $V_{GS} = -3.6 \text{ V}, I_D = -0.38 \text{ A}$  |      | 1.0   | 1.190 | Ω    |  |  |  |
|   |   | $V_{GS} = -2.5 \text{ V}, I_D = -0.25 \text{ A}$  |      | 1.4   | 1.80  |      |  |  |  |
| Forward Transconductance <sup>a</sup>                         | 9fs   | V <sub>DS</sub> = -10 V, I <sub>D</sub> = -0.41 A   |      | 0.8   |       | S    |  |  |  |
| Diode Forward Voltage <sup>a</sup>                            | V <sub>SD</sub>                                 | I <sub>S</sub> = -0.23 A, V <sub>GS</sub> = 0 V   |      | -0.8  | -1.2  | V    |  |  |  |
| Dynamic <sup>b</sup>  |   |   |      |       |       |      |  |  |  |
| Total Gate Charge   | $Q_g$   |   |      | 1.2   | 1.8   | nC   |  |  |  |
| Gate-Source Charge  | Q <sub>gs</sub>                                 | $V_{DS} = -10 \text{ V}, \ V_{GS} = -4.5 \text{ V}, \ I_D = -0.41 \text{ A}$                        |      | 0.45  |       |      |  |  |  |
| Gate-Drain Charge   | Q <sub>gd</sub>                                 |   |      | 0.25  |       |      |  |  |  |
| Turn-On Delay Time  | t <sub>d(on)</sub>                              |   |      | 7.5   | 15    |      |  |  |  |
| Rise Time   | t <sub>r</sub> Vpp = -10 V, R <sub>I</sub> = 20 |   |      | 20    | 40    |      |  |  |  |
| Turn-Off Delay Time   | t <sub>d(off)</sub>                             | $V_{DD}$ = -10 V, $R_L$ = 20 $\Omega$<br>$I_D \cong -0.5$ A, $V_{GEN}$ = -4.5 V, $R_g$ = 6 $\Omega$ |      | 8.5   | 17    | ns   |  |  |  |
| Fall Time   | t <sub>f</sub>                                  |   |      | 12    | 24    |      |  |  |  |
| Source-Drain Reverse Recovery Time                            | t <sub>rr</sub>                                 | I <sub>F</sub> = -0.23 A, di/dt = 100 A/μs  |      | 25    | 40    |      |  |  |  |

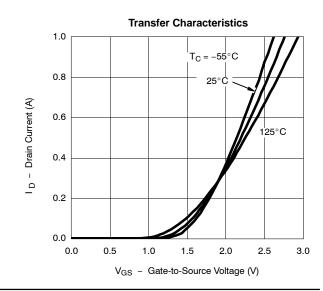
#### Notes

- Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2%.
- Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)







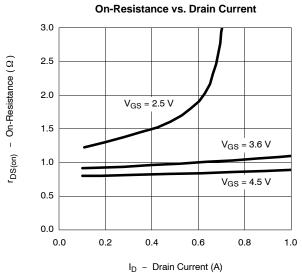


V<sub>GS</sub> - Gate-to-Source Voltage (V)

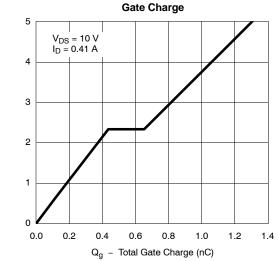
Source Current (A)

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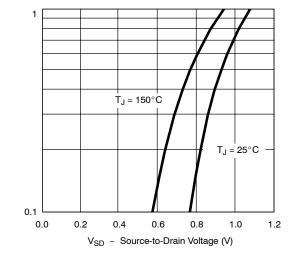
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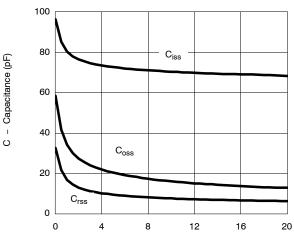




#### Source-Drain Diode Forward Voltage

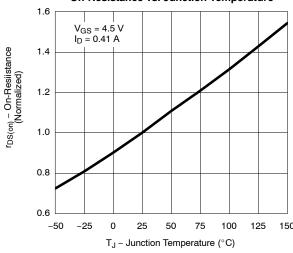


#### Capacitance

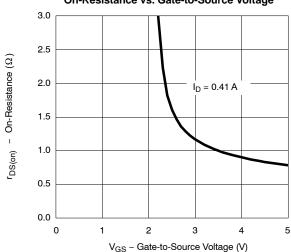


V<sub>DS</sub> - Drain-to-Source Voltage (V)

#### On-Resistance vs. Junction Temperature



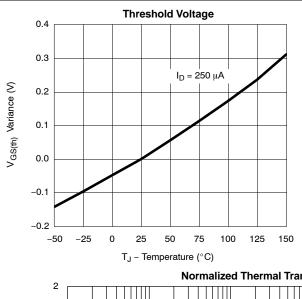
#### On-Resistance vs. Gate-to-Source Voltage

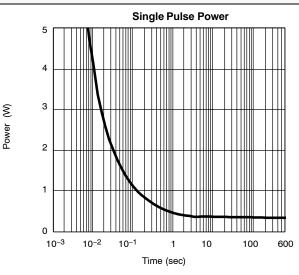


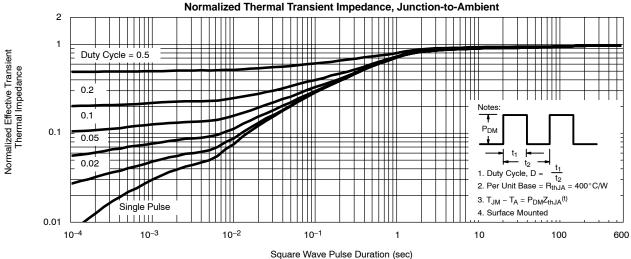
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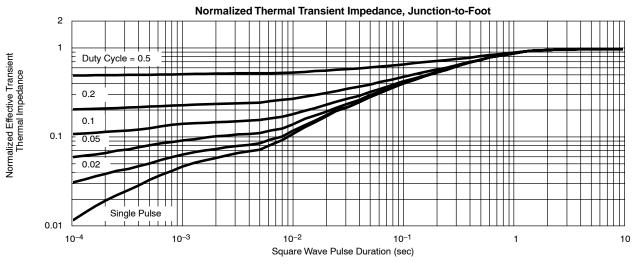


## TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)









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Revision: 18-Jul-08

Document Number: 91000 www.vishay.com